

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

:

Michael Hohmann et al.

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Serial No.: 09/856,661

Group Art Unit: 1743

Filed: August 2, 2001

Examiner: Elizabeth S. Quan

For: INTERCONNECTION SUPPORT FOR PLATE-LIKE MICROCOMPONENTS

REPLY

Mail Stop: Non Fee Amendment

Commissioner for Patents

P. O. box 1450

Alexandria, VA 22313-1450

Sir:

In reply to the Office Action mailed on December 23, 2003, please amend the above-identified application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Formal Drawings are presented at the end of this response.

Remarks/Arguments begin on page 8 of this paper.

I hereby certify that this correspondence is being deposited with the U.S. Postal Services as First Class Mail in an envelope addressed to: Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1450. Washington, D.C. 20231 on: March 23, 2004

Name

Date: /

March 23, 2004